

Overview

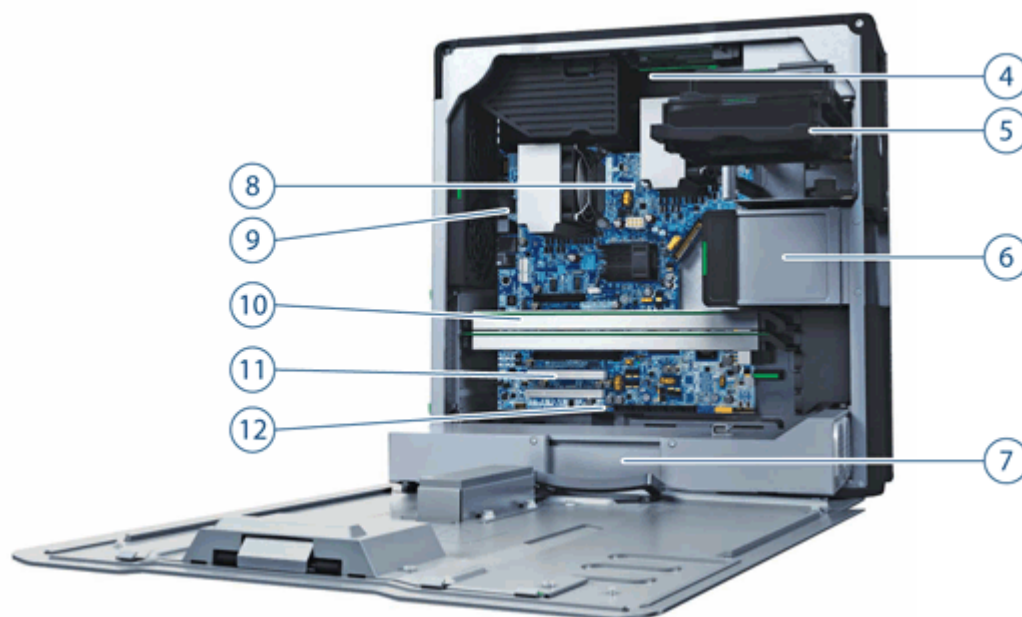
HP recommends Windows Vista®
Business



1. Power Button
2. 2 External 5.25" Bays
3. Front I/O: 3 USB 2.0, 1 IEEE 1394a (optional card required), Headphone, Microphone



Overview



- | | |
|---|--|
| 4. 6 DIMM Slots for DDR3 ECC Memory | 9. Rear I/O: 6 USB 2.0, PS/2 keyboard/mouse
1 RJ-45 to Integrated Gigabit LAN
1 Audio Line In, 1 Audio Line Out, 1 Microphone In |
| 5. 2 Internal 3.5" Bays | |
| 6. 2 External 5.25" Bays | 10. 2 PCIe x16 Gen2 Slots |
| 7. 650W, 85% efficient Power Supply | 11.. 1 PCIe x4 Gen2, 1 PCIe x4 Gen1, 2 PCI Slots |
| 8. 2 Quad Core Intel 5500 Series Processors | 12. 3 Internal USB 2.0 ports |

Form Factor	Minitower
Compatible Operating Systems	Genuine Windows Vista® Business 64-bit* Genuine Windows Vista® Business 32-bit* Genuine Windows Vista® 64-bit downgrade to Genuine Microsoft® Windows® XP Professional 64-bit (expected available until August 2009)** Genuine Windows Vista® 32-bit downgrade to Genuine Microsoft® Windows® XP Professional 32-bit (expected available until August 2009)** HP Linux Installer Kit for Linux (includes drivers for both 32-bit & 64-bit OS versions of Red Hat Enterprise Linux WS4 and WS5 - see: http://www.hp.com/workstations/software/linux) For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_matrix *Certain Windows Vista product features require advanced or additional hardware. See http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit http://www.windowsvista.com/upgradeadvisor. **Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is

Overview

Available Processors	expected to order at least 25 customer systems with the same custom image. Intel® Xeon® Processor X5570 QC 2.93 GHz, 95W, 8M cache, 6.40GT/s QPI, DDR3 1333MHz, HT, Turbo Intel Xeon Processor X5560 QC 2.80 GHz, 95W, 8M cache, 6.40GT/s QPI, DDR3 1333MHz, HT, Turbo Intel Xeon Processor X5550 QC 2.66 GHz, 95W, 8M cache, 6.40GT/s QPI, DDR3 1333MHz, HT, Turbo Intel Xeon Processor E5540 QC 2.53 GHz, 80W, 8M cache, 5.86GT/s QPI, DDR3 1066MHz, HT, Turbo Intel Xeon Processor E5530 QC 2.40 GHz, 80W, 8M cache, 5.86GT/s QPI, DDR3 1066MHz, HT, Turbo Intel Xeon Processor E5520 QC 2.26 GHz, 80W, 8M cache, 5.86GT/s QPI, DDR3 1066MHz, HT, Turbo Intel Xeon Processor E5506 QC 2.13 GHz, 80W, 4M cache, 4.80GT/s QPI, DDR3 800MHz Intel Xeon Processor E5504 QC 2.00 GHz, 80W, 4M cache, 4.80GT/s QPI, DDR3 800MHz
Available Processor Disclaimers	When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details. Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies. 64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information. Intel's numbering is not a measurement of higher performance.
Additional Details	• Intel® Nehalem Architecture • Up to 6.40GT/s QPI support • 3-channel 800/1066/1333 MHz DDR3 memory* subsystem • Up to 24 GB Memory capacity with 6 DIMM slots and 4 GB DIMMs • PCI Express I/O and PCIe x16 Gen2 graphics • Integrated Broadcom 5764 Gigabit LAN on Motherboard (LOM) • 6 channels of Serial ATA (SATA) 3.0 Gb/s natively supported internally • SATA RAID** 0, 1, 5, and 10 support standard on motherboard • SAS RAID 0, 1, and 10 supported using the LSI 3041E PCIe controller • SATA optical drives • High Definition integrated audio with internal speaker • 650W 85% efficient power supply • ENERGY STAR® qualification and energy-saving features available on selected configurations (Not supported by Linux) • Protected by HP Services, including a 3 years parts, 3 years labor, and 3 years onsite service (3/3/3) standard warranty. Terms and conditions vary by country. Certain restrictions and exclusions apply. *Each processor supports up to 3 channels of DDR3 memory. To realize full performance at least 1 DIMM must be inserted into each channel. To get full 6 channel support, 2 processors MUST be installed.

Overview

	**SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.	
Form Factor	Rackable Minitower	
Color	Black/Silver	
I/O Slots (see system board section for more details)	• 2 PCI Express Gen2 x16 slots (full-length, full-height) • 1 PCI Express Gen2 x8 slot - with x8 connectors (full-length, full-height) • 1 PCI Express Gen1 x8 slot - with x8 connectors (full-length, full-height) • 2 PCI 32bit/33MHz slot, (full-length, full-height) • The PCIe x8 connectors are open ended, allowing a PCIe x16 card to be seated in the slot.	
Bays (see storage section for more details)	Total Bays = 4	
Internal Bays	2 internal 3.5" bays (with acoustic dampening rail assemblies)	
External Bays	2 external 5.25" bays (3rd & 4th HDDs occupy one external bay)	
Front I/O	3 USB 2.0, 1 Headphone Out, 1 Microphone In, and 1 IEEE 1394a (For front 1394a port to function, optional 1394 card must be installed.)	
Rear I/O	6 USB 2.0 1 RJ-45 to integrated Gigabit LAN 2 legacy PS/2 1 Audio Line In, 1 Audio Line Out, 1 Microphone In; audio ports can be retasked to function as line in, line out, microphone, or headphone. Serial supported with optional rear bulkhead adapter.	
Internal USB	3 USB 2.0 headers	
Chassis Dimensions (W x D x H)	17.5 x 6.5 x 17.3 in (44.51 x 16.53 x 44 cm)	
Weight	Exact weights depend upon configuration Minimum config – 33.0 lb (15.0 kg) Typical config – 37.4 lb (16.9 kg) Maximum config – 43.3 lb (19.6 kg) (Maximum shipping weight – 52.0 lb / 23.6 kg)	
Temperature	Operating:	40° to 95°F (5° to 35°C)
	Non-operating	–40° to 140° F (–40° to 60° C)
Humidity	Operating:	8% to 85%
	Non-operating	8% to 90%
Maximum Altitude (non-pressurized)	Operating:	10,000 feet; 3,000 m
	Non-operating	30,000 feet; 9,100 m
Power Supply	650W 85% (80PLUS Bronze) Efficient wide-ranging, active Power Factor Correction, with tool-free & cable-free connection	
Interfaces Supported	6-channel SATA 3.0 Gb/s Interface (6 Serial-ATA connectors on the motherboard, 4 channels are eSATA configurable for use with eSATA CTO/AMO Kit) SAS interface supported with optional LSI 3041E 4-port SAS/SATA PCIe card. 1 Floppy interface (1 Floppy connector), USB 2.0	
Hard Drive Controllers Supported	SATA and SAS controllers	

Supported Components

Processors

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Quad-Core Intel Xeon Processor 5500 Series with Intel® 64 Architecture				
Intel Xeon X5570, 2.93GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W	Y	Y	NF153AA	
Intel Xeon X5560, 2.80GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W	Y	Y	NF152AA	
Intel Xeon X5550, 2.66GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W	Y	Y	NF151AA	
Intel Xeon E5540, 2.53GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W	Y	Y	NF150AA	
Intel Xeon E5530, 2.40GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W	Y	Y	NF149AA	
Intel Xeon E5520, 2.26GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W	Y	Y	NF148AA	
Intel Xeon E5506, 2.13GHz, 4MB cache, 800MHz Memory, 4.80 GT/s QPI, 80W	Y	Y	NF147AA	
Intel Xeon E5504, 2.00GHz, 4MB cache, 800MHz Memory, 4.80 GT/s QPI, 80W	Y	Y	NF146AA	

NOTE 1: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.

Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: <http://www.intel.com/info/em64t> for more information.

Intel's numbering is not a measurement of higher performance.

Supported Components

Sub-Section Description/Notes

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

SAS Hard Drives

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations				
146 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Y	Y	EA330AA	
300 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Y	Y	EM174AA	
450 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Y	Y	FM803AA	

Sub-Section Description/Notes

Up to 3 of the following 3.5" SATA and 3.5" 15K SAS drives, or up to 4 of the 2.5" small form factor (SFF) 10K SATA drives are allowed.

(2.5" SFF drives cannot be mixed with 3.5" drives)

SATA Hard Drives

SATA (Serial ATA) Hard Drives for HP Workstations

160 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Y	Y	PV944A	
250 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Y	Y	EA788AA	
320 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Y	Y	FH963AA	
500 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Y	Y	PV943A	
1 TB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Y	Y	GE262AA	
160 GB 10K rpm SATA with NCQ 2.5" Hard Drive	Y	Y	EW222AA	
300 GB 10K rpm SATA with NCQ 2.5" Hard Drive	Y	Y	FM802AA	

NOTE: SAS Controller, not integrated, is required)

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

Supported Components

Hard Drive Controllers

	Factory Configured	Option Kit Option Kit	Option Kit Part Number	Support Notes
Integrated SATA 3.0 Gb/s Controller				
Integrated SATA 3.0 Gb/s Controller, RAID 0, 1, 10, 5 supported	Y	N		
Factory integrated RAID on motherboard for SATA drives				
RAID 0 Configuration - Striped Array	Y	N		See note 1
RAID 1 Configuration - Mirrored Array	Y	N		See note 1
LSI 3041E 4-Port SAS 3.0 Gb/s RAID Card				
LSI 3041E 4-Port SAS 3.0 Gb/s RAID Card	Y	Y	EH417AA	
LSI MegaRAID® SAS 8888ELP Host Bus Adapter (HBA)				
LSI 8888ELP 8-port SAS HW RAID Card	N	Y	GE258AA	
All RAID arrays must be less than 2 TB in size				

NOTE 1: Requires 2 identical hard drives (speeds, capacity, interface). RAID 1 does not support a 3rd HDD. No Linux support for SATA RAID.

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this system with Linux. Please visit: http://www.hp.com/support/linux_hardware_matrix for details.

LSI RAID Definitions:

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit <http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf> for RAID capabilities with Linux.

IS: Striping of 2 or more HDDs into a single logical volume

IM: Mirroring of 2 HDDs into a single logical volume

IME: Mirroring of 3 or more HDDs into a single logical volume

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux_hardware_matrix for details

Supported Components

Graphics

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported Multi Mixed
Professional 2D					
NVIDIA Quadro NVS 295 256MB PCIe Graphics Card	Y	Y	FY943AA	2nd card must be NVS 450 or NVS 295	2 X
NVIDIA Quadro NVS 450 512 MB PCIe Graphics Card	Y	Y	FH519AA	2nd card must be NVS 450 or NVS 295	2 X
NVIDIA Quadro NVS 290 256 MB PCIe Graphics Card with 'DMS-59 to Dual DVI cable' included - for Workstations	N	Y	GN502AA	1 or 2 of these cards are supported - 2nd card must be NVS 290	2
Entry 3D					
NVIDIA Quadro FX 380 256MB PCIe Graphics Card	Y	Y	NB769AA		2
ATI FirePro V3700 256MB PCIe Graphics Card	Y	Y	FY944AA		2
NVIDIA Quadro FX 580 512MB PCIe Graphics Card	Y	Y	FY945AA		2
Mid-range 3D					
NVIDIA Quadro FX 1800 768MB PCIe Graphics Card	Y	Y	FY946AA		2
ATI FirePro V5700 512MB PCIe Graphics Card	Y	Y	FY947AA		2
High End 3D					
NVIDIA Quadro FX 3800 1.0GB PCIe Graphics Card (AVAILABLE JUNE 2009)	Y	Y	FY949AA		1
ATI FirePro V7750 1.0GB PCIe Graphics Card	Y	Y	FY948AA		1
NVIDIA Quadro FX 4800 1.5GB PCIe Graphics Card	Y	Y	FQ138AA		1
NVIDIA Quadro CX - The Accelerator for Creative Suite 4	Y	N			1

Supported Components

Memory

CTO

PC3-10600 DDR3-1333 ECC Unbuffered DIMMs CTO

1GB (1x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU
 2GB (2x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU
 3GB (3x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU
 4GB (2x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU
 6GB (3x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU
 8GB (2x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU
 12GB (3x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU
 2GB (2x1GB) DDR3-1333 ECC Unbuffered RAM 2-CPU
 4GB (4x1GB) DDR3-1333 ECC Unbuffered RAM 2-CPU
 4GB (2x2GB) DDR3-1333 ECC Unbuffered RAM 2-CPU
 6GB (6x1GB) DDR3-1333 ECC Unbuffered RAM 2-CPU
 8GB (4x2GB) DDR3-1333 ECC Unbuffered RAM 2-CPU
 8GB (2x4GB) DDR3-1333 ECC Unbuffered RAM 2-CPU
 12GB (6x2GB) DDR3-1333 ECC Unbuffered RAM 2-CPU
 16GB (4x4GB) DDR3-1333 ECC Unbuffered RAM 2-CPU
 24GB (6x4GB) DDR3-1333 ECC Unbuffered RAM 2-CPU

Support Notes

Both processor sockets must be populated.
 Both processor sockets must be populated.
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 Both processor sockets must be populated.
 Both processor sockets must be populated.
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 Both processor sockets must be populated.

Sub-Section Description/Notes

NOTE: The Z600 has a three-channel memory architecture. Three channels are associated with each processor. For optimal performance, populate a DIMM in each channel.

AMO

PC3-10600 DDR3-1333 ECC Unbuffered DIMMs AMO

1GB (1x1GB) DDR3-1333 ECC Unbuffered RAM
 2GB (1x2GB) DDR3-1333 ECC Unbuffered RAM
 4GB (1x4GB) DDR3-1333 ECC Unbuffered RAM

NOTE: Although all of these memory configurations incorporate 1333MHz memory modules, the speed at which they operate is dependent upon the processor.

Supported Components

Multimedia and Audio Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated Intel/Realtek HD ALC262 Audio	Y	N		
HP Thin USB Powered Speakers	Y	Y	KK912AA	
Creative X-Fi Titanium PCIe Audio Card	Y	Y	NH222AA	

Optical and Removable Storage

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP 16X DVD-ROM SATA Drive	Y	Y	AR629AA	See note 1
HP 16X DVD+-RW SuperMulti SATA Drive	Y	Y	AR630AA	
HP Slot Load DVD+-RW Drive	Y	N		
HP Blu-ray Writer	Y	Y	AR482AA	
1.44 MB Diskette Drive (1 only)	Y	Y	NK360AA	
HP 22-in-1 Media Card Reader Kit (Workstations)	Y	Y	NK361AA	
HP DX115 Removable Drive Enclosure				
HP DX115 Carrier with 160GB SATA HDD	N	Y	FZ577AA	
HP DX115 Removable HDD Frame/Carrier	N	Y	FX576AA	
HP DX115 Removable HDD Carrier	N	Y	NB792AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd Optical Drive.

Controller Cards

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP FireWire/IEEE 1394a PCI Card	Y	Y	PA997A	
HP IEEE 1394b FireWire PCIe Card	Y	Y	NK653AA	

Supported Components

Monitors

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP LP3065 30-inch Widescreen LCD Monitor	Y	Y	EZ320A	
HP DreamColor LP2480zx Professional Display	Y	Y	GV546A	
HP LP2475w 24-inch Widescreen LCD Monitor	Y	Y	KD911A	
HP LP2275w 22-inch Widescreen LCD Monitor	Y	Y	KE289A	
HP LP1965 19-inch LCD Monitor	Y	Y	RA373A	

NOTE: Supported by all Operating Systems available from HP (screen size diagonally measured)

Networking and Communications

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated Broadcom 5764 PCIe LOM Controller	Y	N		
Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Y	Y	FS215AA	
HP NC360T PCI Express Dual Port Gigabit NIC	N	Y	KU004AA	
Intel Gigabit CT Desktop NIC	N	Y	FH969AA	

The Broadcom NetXtreme Plus card may be used, along with the integrated 5764 LOM, for teaming, redundancy, or additional network bandwidth.

"Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Security Cable with Kensington Lock	N	Y	PC766A	
HP Solenoid Hood Lock & Hood Sensor	Y	N		
HP (CMT) Solenoid Lock	N	Y	DE618A	
HP Z6/Z8 Adjustable Sliding Rail Rack Kit	N	Y	NN124AA	

Supported Components

Input Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP PS/2 Standard Keyboard	Y	Y	DT527A	
HP USB Standard Keyboard	Y	Y	DT528A	
HP PS/2 Optical Scroll Mouse	Y	Y	EY703AA	
HP USB 2-Button Optical Scroll Mouse	Y	Y	DC172B	
HP USB Laser Mouse	Y	Y	GW405AA	
HP USB Optical 3-Button Mouse	Y	Y	DY651A	
HP USB Smart Card Keyboard	N	Y	ED707AA	
HP 2.4GHz Wireless Keyboard & Mouse	N	Y	NB896AA	
HP USB Optical 3-Button 2.9M OEM Mouse	N	Y	ET424AA	
HP SpaceExplorer 3D USB Controller	N	Y	RY429AA	
HP SpacePilot 3D USB Intelligent Controller	N	Y	EF390AA	

Other Hardware

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Workstation Mouse Pad	Y	N		Japan only.
HP Power Cord Kit	N	Y	DM293A	
HP eSATA PCI Cable Kit	N	Y	GM110AA	
HP 2nd Serial Port Adapter	N	Y	PA716A	Provides 1st Serial Port for the Z600.
HP Internal USB Port Kit	N	Y	EM165AA	
HP Workstation to LTO SAS Int. Cable	N	Y	EH925A	
HP Optical Bay HDD Mounting Bracket	Y	Y	NQ099AA	For 3.5" HDDs
HP ENERGY STAR 5.0 Enabled Configuration	Y	N		

Supported Components

Software

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Performance Tuning Framework	Y	N		
Roxio Easy Media Creator (CD or DVD burner)	Y	N		
Intervideo WinDVD with DVD player	Y	N		
HP Backup and Recovery	Y	N		Supported on Windows XP ONLY
PDF Complete	Y	N		
Microsoft Office 2007 Small Business Edition	Y	N		
Microsoft Office 2007 Trial Edition	Y	N		
HP Client Manager Software v6.2 (optional download)	Y	N		
HP ProtectTools Security	Y	N		Must select as a Configure to Order Option. Delivered as a "Drop in the Box" CD

Operating Systems

Support Notes

Genuine Windows Vista® Business 32-bit	Certain Windows Vista product features require advanced or additional hardware. See www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit www.windowsvista.com/upgradeadvisor .
Genuine Windows Vista® Business 64-bit	Certain Windows Vista product features require advanced or additional hardware. See www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit www.windowsvista.com/upgradeadvisor .
Genuine Windows Vista® Business 32-bit with downgrade to Windows® XP Professional 32-bit custom installed	Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.
Genuine Windows Vista® Business 64-bit with downgrade to Windows® XP Professional x64 custom installed	Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.
HP Linux Installer Kit	see: http://www.hp.com/workstations/software/linux

System Technical Specifications

System Board																																																																																																																			
System Board Form Factor	14.2 x 11 inches																																																																																																																		
Processor Socket	Dual LGA 1366																																																																																																																		
CPU Bus Speed	QPI: Up to 6.4GT/second, depending on processor																																																																																																																		
Chipset	Intel® 5520																																																																																																																		
Super I/O Controller	SMSC SCH5327, Rev B																																																																																																																		
Memory Expansion Slots	6 (3 per processor)																																																																																																																		
Memory Type Supported	DDR3, UDIMM (Unbuffered), ECC																																																																																																																		
Memory Modes	NUMA (Non-Uniform Memory Architecture), Memory Node Interleave																																																																																																																		
Memory Speed Supported	800, 1066, & 1333MHz																																																																																																																		
Memory																																																																																																																			
Maximum Memory	Supports up to 24GB																																																																																																																		
	<table><tr><td></td><th colspan="6">Dual Processor</th></tr><tr><td></td><th colspan="3">CPU0</th><th colspan="3">CPU1</th></tr><tr><td>Capacity</td><td>DDMM1</td><td>DDMM2</td><td>DDMM3</td><td>DDMM1</td><td>DDMM2</td><td>DDMM3</td></tr><tr><td>2GB</td><td>1GB</td><td></td><td></td><td>1GB</td><td></td><td></td></tr><tr><td>4GB</td><td>1GB</td><td>1GB</td><td></td><td>1GB</td><td>1GB</td><td></td></tr><tr><td>4GB</td><td>2GB</td><td></td><td></td><td>2GB</td><td></td><td></td></tr><tr><td>6GB</td><td>1GB</td><td>1GB</td><td>1GB</td><td>1GB</td><td>1GB</td><td>1GB</td></tr><tr><td>8GB</td><td>2GB</td><td>2GB</td><td></td><td>2GB</td><td>2GB</td><td></td></tr><tr><td>12GB</td><td>2GB</td><td>2GB</td><td>2GB</td><td>2GB</td><td>2GB</td><td>2GB</td></tr><tr><td>16GB</td><td>4GB</td><td>4GB</td><td></td><td>4GB</td><td>4GB</td><td></td></tr><tr><td>24GB</td><td>4GB</td><td>4GB</td><td>4GB</td><td>4GB</td><td>4GB</td><td>4GB</td></tr></table> <table><tr><td></td><th colspan="3">Single Processor - CPU0</th></tr><tr><td>Capacity</td><td>DDMM1</td><td>DDMM2</td><td>DDMM3</td></tr><tr><td>1GB</td><td>1GB</td><td></td><td></td></tr><tr><td>2GB</td><td>1GB</td><td>1GB</td><td></td></tr><tr><td>3GB</td><td>1GB</td><td>1GB</td><td>1GB</td></tr><tr><td>4GB</td><td>2GB</td><td>2GB</td><td></td></tr><tr><td>6GB</td><td>2GB</td><td>2GB</td><td>2GB</td></tr><tr><td>8GB</td><td>4GB</td><td>4GB</td><td></td></tr><tr><td>12GB</td><td>4GB</td><td>4GB</td><td>4GB</td></tr></table>			Dual Processor							CPU0			CPU1			Capacity	DDMM1	DDMM2	DDMM3	DDMM1	DDMM2	DDMM3	2GB	1GB			1GB			4GB	1GB	1GB		1GB	1GB		4GB	2GB			2GB			6GB	1GB	1GB	1GB	1GB	1GB	1GB	8GB	2GB	2GB		2GB	2GB		12GB	2GB	2GB	2GB	2GB	2GB	2GB	16GB	4GB	4GB		4GB	4GB		24GB	4GB	4GB	4GB	4GB	4GB	4GB		Single Processor - CPU0			Capacity	DDMM1	DDMM2	DDMM3	1GB	1GB			2GB	1GB	1GB		3GB	1GB	1GB	1GB	4GB	2GB	2GB		6GB	2GB	2GB	2GB	8GB	4GB	4GB		12GB	4GB	4GB	4GB
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Memory Configuration (Supported)	● Not all memory configurations possible are represented below. ● Only ECC DIMMs are supported. ● Do not install memory modules into memory slots if corresponding processor is not installed. ● Dual processor configurations with memory modules installed for only one processor is not supported. ● The 4GB DIMM for Z400 and Z600 is not compatible with the Z800 4GB DIMM. They are not interchangeable.																																																																																																																		
PCI Express Connectors (Gen2 Rev 0.7 connectors)	2 PCI Express x16 Gen2 graphics 1 PCI Express Gen2 (x8 mechanically, x4 electrically) 1 PCI Express Gen1 (x8 mechanically, x4 electrically)																																																																																																																		
PCI Connectors (5.0V)	2 full length 33 MHz 32-Bit																																																																																																																		
Interfaces Supported	SATA	Integrated 6-channel SATA 3.0Gb/sec controller with RAID 0, 1, 5, 10 and NCQ. (Factory integrated RAID is Microsoft Windows only)																																																																																																																	
Serial Attached SCSI	Requires Optional PCIe card																																																																																																																		
Integrated RAID	● Integrated SATA RAID																																																																																																																		



System Technical Specifications

	• RAID 0, RAID 1*, RAID 5, RAID 10 • Supports one RAID array with 2-4 drives • RAID 0 configuration - striped array (supported and configure to order) • RAID 1 configuration - mirrored array (supported and configure to order) • RAID 5 parity striping (supported but not configure to order) • RAID 10 striped and mirrored array (supported but not configure to order) NOTES: *HW RAID functionality not supported by Linux. Use SW RAID functionality provided in the Red Hat Operating system instead.	
Integrated Graphics	No	
Network Controller	Controller Broadcom 5764 PCI-E LAN Controller Memory Integrated 48KB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mbps Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCIe 1.0a Data path width X1 Data path speed 2.5Gbit per sec per direction transfer rate Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professional 32 and 64 Management capabilities WOL, PXE 2.1 and ASF 2.0	
SATA Connectors	6 ports/connectors (Include 4 are eSATA configurable with optional eSATA After-Market Option cable kit)	
IEEE 1394a or 1394b	No integrated 1394a - optional PCI card required. No integrated 1394b - optional PCIe card required. Cable from Front IO can be plugged into PCI Card. Not supported in Linux	
IEEE 1394 Connector(s)	Front	1 IEEE 1394a (requires optional PCI card to function)
	Rear	No
	Internal	No
USB Connector(s)	Front	3 on header for front
	Rear	6
	Internal	3
Audio	High Definition Integrated Realtek ALC262 Audio with Line in, Line Out, Microphone, Headphone	
CD-ROM input/Audio	No	
AUX INPUT; Audio	Yes	
IEEE 1394 Connector(s)	Front	1 IEEE 1394a (requires optional PCI card to function)
	Rear	No
	Internal	No

System Technical Specifications

USB Connector(s)	Front	3 on header for front
	Rear	6
	Internal	3
HD Integrated Audio	High Definition Integrated Realtek ALC262 Audio with Line in, Line Out, Microphone, Headphone Line-in, Line-out, Mic-in x2, and Headphone jacks	
Flash ROM	Yes	
Clear Fan Header	No	
CPU Fan Header	One for each CPU socket	
Chassis Fan Header	2 Rear System Chassis Fan Header 1 Optional Front Chassis Fan Header	
Front PCI Fan Header	Yes	
Front Control Panel/Speaker Header	Yes	
CMOS Battery Holder - Lithium	Yes	
Integrated Trusted Platform Module	TPM 1.2, Infineon	
Power Supply Headers	Yes	
Power Switch, Power LED & Hard Drive LED Header	Yes	
Clear Password Jumper	Yes	
Serial Port	Optional	
Parallel Port	No	
Keyboard/Mouse	PS/2	
Power Supply	650 watt 85% efficient custom power supply (Wide Ranging, Active PFC)	
Operating Voltage Range	90-269 VAC	
Rated Voltage Range	100 - 240 VAC 118 VAC	
Rated Line Frequency	50/60Hz 400Hz	
Operating Line Frequency Range	47-66Hz 393-407 Hz	
Rated Input Current	10 A @ 100-127 VAC; 6 A @ 200-240 VAC 10 A @ 118 VAC	
Heat Dissipation	Typical = 434 btu/hr (109 kg-cal/hr) Maximum = 964 btu/hr (243 kg-cal/hr)	
Power Supply Fan	92x25 mm variable speed	
ENERGY STAR® qualified (Config Dependent)	Yes	
80 PLUS Compliant	Yes	

System Technical Specifications

FEMP Standby Power Compliant 115V (Wake-on LAN disabled) (<2W in S5 - Power Off)	Yes
Power consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3)	<5W
Built-in Self Test (BIST) LED	Yes
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Withstands power surges up to 2000V
Hood Lock Header	Yes
Hood Sensor Header	Yes Integrated in Front Control Panel Cable
Multibay Header	No
Integrated Gigabit Ethernet	Integrated Broadcom 5764 Gigabit Ethernet LOM
Wake on LAN	Yes
ASF 1.0/2.0 (Alert Standard Format)	Yes
TPM	Integrated TPM 1.2; Infineon
Password Clear Header	Yes
CD-ROM ; analog audio cable	No
AUX ; analog audio in	No
Clear CMOS Button	Yes
Chassis Speaker Header	Yes (Integrated in Front Control Panel Cable)
ENERGY STAR® qualified (Config Dependent)	Yes

System Technical Specifications

Z600 Required Power Supply Info		
Power Supply	650 watt custom power supply - (Wide Ranging Active PFC)	
Operating Voltage Range	90 - 269 VAC	
Rated Voltage Range	100 - 240 VAC	118 VAC
Rated Line Frequency	50-60 Hz	400 Hz
Operating Line Frequency Range	47 - 66 Hz	393 - 407 Hz
Rated Input Current	10 A @ 110-127 VAC 6 A @ 200-240 VAC	10 A @ 118 VAC
Heat Dissipation (Configuration and software dependent)	Typical 1578 btu/hr (397.7 kg-cal/hr) Maximum 2705 btu/hr (681.8 kg-cal/hr)	
Power Supply Fan	2x60x25 mm variable speed (sleeve-bearing) fans	
Energy Star Compliant (config dependent)	YES	
80 PLUS® Compliant	Yes, Bronze	
FEMP Standby Power Compliant@115V (Wake-on LAN disabled)(<2 W in S5-Power Off)	YES	
EuP Compliant@230V (<1 W in S5-Power Off)	YES	
Power Consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3) (Instantly Available PC) measured at 115V.	<9 W	
Built-in Self Test LED	YES	
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	YES	

System Technical Specifications

System Configuration

Example Configuration #1

Processor Info 1x Intel Xeon E5506
Memory Info 1x1 GB DDR3 1333 (UDIMM)
Graphics Info NVS290
Disks/Optical/Floppy 1x1 60GB SATA / 0 Optical / 0 Floppy
PSU 650W 80PLUS® BRONZE

Energy Consumption

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	62.2 W		61.8 W		63.1 W	
Windows Busy Typ (S0)	117.9 W		114.9 W		118.2 W	
Windows Busy Max (S0)	156.9 W		155.1 W		157.5 W	
Sleep (S3)	3.71 W	3.47 W	4.05 W	3.84 W	3.69 W	3.44 W
Off (S5)	1.14 W	1.32 W	1.45 W	1.32 W	1.12 W	0.99 W
Zero Power Mode (EuP)	0.24 W		0.52 W		0.29 W	

Heat Dissipation**

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	212.4 btu/hr		210.8 btu/hr		215.2 btu/hr	
Windows Busy Typ (S0)	402.3 btu/hr		392.0 btu/hr		403.4 btu/hr	
Windows Busy Max (S0)	535.6 btu/hr		529.3 btu/hr		538.1 btu/hr	
Sleep (S3)	12.7 btu/hr	11.8 btu/hr	13.8 btu/hr	13.1 btu/hr	12.6 btu/hr	11.7 btu/hr
Off (S5)	3.9 btu/hr	4.5 btu/hr	4.9 btu/hr	4.5 btu/hr	3.8 btu/hr	3.4 btu/hr
Zero Power Mode (EuP)	0.8 btu/hr		1.77 btu/hr		0.7 btu/hr	

Example Configuration #2

Processor Info 2x Intel Xeon E5506
Memory Info 2x1 GB DDR3 1333MHz (UDIMM)
Graphics Info 1x FX580
Disks/Optical/Floppy 1x 250GB SATA / 0 Optical / 0 Floppy
PSU 650W 80PLUS® BRONZE

Energy Consumption

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	89.2 W		87.8 W		90.0 W	
Windows Busy Typ (S0)	294.1 W		287.8 W		294.9 W	
Windows Busy Max (S0)	313.5 W		307.3 W		317.0 W	
Sleep (S3)	5.08 W	4.84 W	5.43 W	5.25 W	5.05 W	4.82 W
Off (S5)	1.14 W	1.01 W	1.45 W	1.32 W	1.12 W	0.99 W
Zero Power Mode (EuP)	0.24 W		0.52 W		0.22 W	

Heat Dissipation**

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	304.5 btu/hr		299.5 btu/hr		307 btu/hr	
Windows Busy Typ (S0)	1003.8 btu/hr		982.3 btu/hr		1006.5 btu/hr	
Windows Busy Max (S0)	1070 btu/hr		1048.8 btu/hr		1081.9 btu/hr	
Sleep (S3)	17.3 btu/hr	16.5 btu/hr	18.5 btu/hr	17.9 btu/hr	17.2 btu/hr	16.5 btu/hr



System Technical Specifications

Example Configuration #3

Off (S5)	3.9 btu/hr	3.5 btu/hr	5.0 btu/hr	4.5 btu/hr	3.8 btu/hr	3.38 btu/hr
Zero Power Mode (EuP)	0.8 btu/hr		1.8 btu/hr		0.8 btu/hr	

Processor Info 2x Intel Xeon X5570
 Memory Info 6x2GB DDR3 1333MHz (UDIMM)
 Graphics Info 1 x FX4800
 Disks/Optical/Floppy 2x1000GB SATA / 1 Optical / 1 Floppy
 PSU 1xBroadcom 5761 Gigabit PCIe NIC
 650W 80PLUS® BRONZE

Energy Consumption

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	123.3 W		119.9 W		123.6 W	
Windows Busy Typ (S0)	455.7 W		443.0 W		462.3 W	
Windows Busy Max (S0)	564.8 W		554.4 W		570.7 W	
Sleep (S3)	7.0 W	6.28 W	7.2 W	6.61 W	7.0 W	6.27 W
Off (S5)	1.6 W	0.90W	1.9 W	1.21W	1.6 W	0.88 W
Zero Power Mode (EuP)	0.24 W		0.51 W		0.22 W	

Heat Dissipation**

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	420.8 btu/hr		409.2 btu/hr		421.8 btu/hr	
Windows Busy Typ (S0)	1555.3 btu/hr		1512.0 btu/hr		1577.8 btu/hr	
Windows Busy Max (S0)	1927.7 btu/hr		1892.2 btu/hr		1947.8 btu/hr	
Sleep (S3)	23.9 btu/hr	21.4 btu/hr	24.6 btu/hr	22.6 btu/hr	23.9 btu/hr	21.4 btu/hr
Off (S5)	5.5 btu/hr	3.1 btu/hr	6.5 btu/hr	4.1 btu/hr	5.5 btu/hr	3.0 btu/hr
Zero Power Mode (EuP)	0.8 btu/hr		1.7 btu/hr		0.8 btu/hr	

System Technical Specifications

Example Configuration #4 (ENERGY STAR Qualified)

Processor Info	2x Intel Xeon X5570
Memory Info	6x2GB DDR3 1333MHz (UDIMM)
Graphics Info	1 x FX4800
Disks/Optical/Floppy	2x1000GB SATA / 1 Optical / 1 Floppy
I/O	1xBroadcom 5761 Gigabit PCIe NIC
PSU	650W 80PLUS® BRONZE

Energy Consumption

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
On-Idle (ENERGY STAR® Idle (S0))	123.3 W		119.9 W		123.6 W	
ENERGY STAR® P _{MAX} Windows running Linpack and Vneper [†]	455.7 W		443.0 W		462.3 W	
ENERGY STAR® "Sleep" (S3)	7.0 W	-	7.2 W	-	7.0 W	-
ENERGY STAR® "Standby" (Off) (S5)	1.6 W	-	1.9 W	-	1.6 W	-

Heat Dissipation**

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
On-Idle (ENERGY STAR® Idle (S0))	420.8 <u>btu/hr</u>		409.2 <u>btu/hr</u>		421.8 <u>btu/hr</u>	
ENERGY STAR® P _{MAX} Windows running Linpack and Vneper [†]	1555.3 <u>btu/hr</u>		1512.0 <u>btu/hr</u>		1577.8 <u>btu/hr</u>	
ENERGY STAR® "Sleep" (S3)	23.9 <u>btu/hr</u>	-	24.6 <u>btu/hr</u>	-	23.9 <u>btu/hr</u>	-
ENERGY STAR® "Standby" (Off) (S5)	5.5 <u>btu/hr</u>	-	6.5 <u>btu/hr</u>	-	5.5 <u>btu/hr</u>	-

NOTES:

* Energy Star low energy mode

** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (Entry-level and High-end configurations)

Declared Noise Emissions (Entry-level and High-end configurations)		
System Configuration (Entry level)	Processor Info	Dual Intel Xeon X5570 2.93Ghz processors
	Memory Info	4 x 1GB 1333Mhz
	Graphics Info	nVidia Quadro NVS 295
	Disks/Optical/Floppy	2x 250GB 7200 rpm SATA / 1 DVD-ROM/ 1 Floppy

System Technical Specifications

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure
	Idle	4.1	24
	SATA Hard drive Operating (random reads)	4.2	26
	Floppy Drive Operating (continuous copy)	4.8	33
	DVD-ROM Operating (sequential reads)	5.1	36

System Configuration (High-end)	Processor Info	Dual Intel Xeon X5570 2.93GHz processors
	Memory Info	6 x 2GB 1333 Mhz
	Graphics Info	nVidia FX4800
	Disks/Optical/Floppy	2x300GB 15k SAS / 1 DVD-ROM/ 1 Floppy

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure
	Idle	4.7	28
	SATA Hard drive Operating (random reads)	4.9	31
	Floppy Drive Operating (continuous copy)	5.1	36
	DVD-ROM Operating (sequential reads)	5.3	30

Environmental Requirements	Temperature	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 10,000 feet (3,000 m) Non-operating: 30,000 feet (9,100 m)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 5000 ft (1524 m) altitude, maximum operating temperature is de-rated by 1.8° F (1° C) per 1000 ft (305 m) elevation increase

System Technical Specifications

Physical Security and Serviceability	
Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less
Floppy Drive	Tool-less
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less
Green User Touch Points	Yes, on tool-free internal chassis components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD Set	Restores the computer to its original factory shipping image - Can be obtained via HP Support
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED on System PCA	Yes

System Technical Specifications

NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
Power supply diagnostic LED	Yes
Power Button	Yes, ACPI multi-function
Power LED	Yes, blue (normal), red (fault)
Hard drive activity LED	Yes, green
Internal speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.
OS CD (Restore OS CD)	Restores computer to its original factory shipping Operating System - No recovery CDs will ship with Windows XP, Vista or Linux - an ISO image will be available on an HD partition.
ASF 2.0 support (Alert Standard Format)	Industry-standard specification for network alerting in operating system-absent environments
Cooling Solutions	Air cooled forced convection
Power Supply Fans	2x -- 60mm x 25mm
CPU Heatsink Fan(s)	80mm x 15mm
Chassis Fans	Rear: 2x -- 92mm x 25mm Front: 80mm x 25mm
Memory Fans	80mm x 25mm
Insight Diagnostics	HP Insight Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to: • Run diagnostics • View the hardware configuration of the system Key features and benefits HP Insight Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest insight into potential system issues, is the configuration of the system. Insight Diagnostics helps provide higher system availability. Typical uses of the Insight Diagnostics are: • Testing and diagnosing apparent hardware failures • Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance • Sending configuration information to another location for more in-depth analysis
Access Panel Key Lock	Yes, prevents removal of the access panel and all internal components including optical and floppy drives

System Technical Specifications

ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI). - Allows the system to wake from a low power mode. - Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system
Trusted Platform Module Chip with optional ProtectTools Software	Yes, Infineon SLB9635TT1.2
Integrated Chassis Handles	Yes
Power Supply	Tool-less, direct-connect (blind-mate)
PCI Card Retention	Yes, rear (all), middle (full-height cards), front (full-length with extender cards)
Flash ROM	SPI ROM
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder for easy Replacement	Yes
DIMM Connectors for easy Upgrade	Yes
HP ProtectTools Security Manager	Yes - Not supported on Microsoft XP x64 or Linux

BIOS	
BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0
BBS	BIOS Boot Specification v1.01
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01 +	Provides more control over how and from what devices the workstation will boot.
BIOS Power On	Users can define a specific date and time for the system to power on
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.5, previously known as DMI BIOS, for system management information
Boot Control	Disables the ability to boot from removable media on supported devices
Memory Change Alert	Alerts management console if memory is removed or changed

System Technical Specifications

Thermal Alert	Monitors the temperature state within the chassis. Three modes: ● NORMAL - normal temperature ranges ● ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown ● SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console
ACPI (Advanced Configuration and Power Management Interface)	● Allows the system to enter and resume from low power modes (sleep states).] ● Enables an operating system to control system power consumption based on the dynamic workload. ● Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. ● Supports ACPI 2.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location
ASF 2.0 Compliant	Allows workstation status to be monitored on a remote console
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.
System board revision level	● Allows management SW to read the revision level of the system board ● Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing
Auto Setup when new hardware installed	System automatically detects the addition of new hardware
Keyboard-less Operation	The system can be booted without a keyboard
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memory
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED
Industry Standard Specification Support	
Industry Standard	Revision Supported by the BIOS
ACPI	Advanced Configuration and Power Management Interface, Version 2.0
ASF	Alert Standard Format Specification, Version 2.0

System Technical Specifications

ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	- PCI Local Bus Specification, Revision 2.3 - PCI Power Management Specification, Revision 1.1 - PCI Firmware Specification, Revision 3.0, Draft 0.7
PCI Express	PCI Express Base Specification, Revision 2.0
PMM	POST Memory Manager Specification, Version 1.01
SATA	- Serial ATA Specification, Revision 1.0a - Serial ATA 3.0Gb/s: Extensions to Serial ATA 1.5Gb/s, Revision 1.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
TPM	Trusted Computing Group TPM Specification Version 1.2
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB 1.1	Universal Serial Bus Revision 1.1 Specification
USB 2.0	Universal Serial Bus Revision 2.0 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.6

System Software Management and Updating

HP Client Management Solutions	Visit: http://www.hp.com/go/easydeploy
Product Change	- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. - PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. - Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.
Support Software CD & WWW	Yes
HP Client Manager	Visit: http://www.hp.com/go/easydeploy
System Software Manager (free)	Visit: http://www.hp.com/go/ssm
Social and Environmental Responsibility	
Eco-Label Certifications & Declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: - ENERGY STAR (Configuration dependent, Microsoft Windows only) - US Federal Energy Management Program (FEMP) - China Energy Conservation Program - IT ECO declaration - Japan PC Green label* *This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'

System Technical Specifications

Batteries	This product complies with ISO standards: • EU Directive 91/ 157/ EEC • EU Directive 93/ 86/ EEC • EU Directive 98/ 101/ EEC Batteries used in the product do not contain: • Mercury greater than 5ppm by weight • Cadmium greater than 10ppm by weight • Lead greater than 4000ppm by weight Battery size: CR2032 (coin cell) Battery type: Lithium
Restricted Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html): • Asbestos • Batteries - Mercury • Batteries - Cadmium • Batteries - Lead (non-rechargeable) • Batteries - Non-rechargeable Alkaline and Carbon-Zinc Batteries • Batteries - Classification as "Not Restricted" for Transport • Brominated Flame Retardants (PBBs, PBDEs, including DecaBDE) • Brominated Flame Retardants (all BFRs in external case plastic parts) • Cadmium and its compounds • Certain Azo Colorants • Chlorinated Hydrocarbons • Chlorinated Paraffins • Formaldehyde • Formaldehyde - emissions • Hexavalent Chromium and its compounds in metallic applications • Hexavalent Chromium and its compounds in non-metallic applications • Lead and its compounds • Lead in paint • Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords • Mercury and its compounds • Nickel on external surfaces • Ozone Depleting Substances (ODS) • Polycyclic Aromatic Hydrocarbons (PAH) • Perfluorooctane sulfonates (PFOS) in parts • Perfluorooctane sulfonates (PFOS) in preparations • Polychlorinated Biphenyls (PCBs) and Polychlorinated Terphenyls (PCTs) • Polychlorinated Naphthalenes • Polyvinyl Chloride (PVC) in external case plastic parts • Radioactive Substances • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging	HP Workstation product packaging meets the following (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

System Technical Specifications

	- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment (see link above). - Does not contain ozone-depleting substances (ODS). - Design packaging materials for ease of disassembly. - Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed. - Maximizes the use of post-consumer recycled content materials in packaging materials. - All packaging material is recyclable. - Reduces size and weight of packages to improve transportation fuel efficiency. - Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
Longevity and Upgrading	This product is designed to be upgraded, possibly extending its useful life by several years. Spare parts are available throughout the warranty period and for up to 5 years after the end of production. Upgradeability features contained in the product include: - Intel LGA771 processor socket 8 USB ports (5 rear, 2 front, 1 internal) 2 PCI slots and 4 PCI Express slots 5/6 storage bays (2 - 3.5 inch OR 3 - 2.5" internal, 1 - 3.5 inch FDD, 2 - 5.25 inch removable) 8 memory slots
Packaging Materials	
External	Cardboard carton and insert: 1.537 kg
Internal	LDPE Foam: .740 kg
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: [link to new HP white paper now in progress] Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications: http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html
Service, Support and Warranty	On-site Warranty and Service (Note 1): This three-year, limited warranty and service offering delivers three years of on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) service for parts and labor and includes free telephone support (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries. HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location
Additional Information	This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.

System Technical Specifications

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by weight)
- This product is >90% recycle-able when properly disposed of at end of life.

Technical Specifications - Processors

Processors	Intel Xeon E5504, 2.00GHz, 4MB cache, 800MHz Memory, 4.80 GT/s QPI, 80W
	Intel Xeon E5506, 2.13GHz, 4MB cache, 800MHz Memory, 4.80 GT/s QPI, 80W
	Intel Xeon E5520, 2.26GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W
	Intel Xeon E5530, 2.40GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W
	Intel Xeon E5540, 2.53GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W
	Intel Xeon X5550, 2.66GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W
	Intel Xeon X5560, 2.80GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W
	Intel Xeon X5570, 2.93GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W

Introduction

Intel's latest-generation microarchitecture represents the next step in unprecedented processor performance and dynamic scalability. Designed from the ground up to take advantage of hafnium-based Intel® 45nm hi-k metal gate silicon technology, Intel® Microarchitecture (Nehalem) unleashes parallel processing performance enabled by Intel® QuickPath technology providing an integrated memory controller and high-speed interconnect per independent processing core.

Performance and Features

Maximum multitasking performance Intel® Microarchitecture (Nehalem) offers the latest in processor innovation, including:

- Dynamic scalability, managed cores, threads, cache, interfaces, and power for energy-efficient performance on demand.
- Design and performance scalability for servers, workstations, notebooks and desktops with support for 2-8+ cores and up to 16+ threads with Intel® Hyper-Threading Technology (Intel® HT Technology), and scalable cache sizes, system interconnects, and integrated memory controllers.
- Intel® Turbo Boost Technology delivers additional performance automatically when needed by taking advantage of the processor's power and thermal headroom. This enables increased performance of both multi-threaded and single-threaded workloads.
- Intel Hyper-Threading Technology brings high-performance applications into mainstream computing with 1-16+ threads optimized for a new generation multi-core processor architecture.
- Scalable shared memory of Intel® QuickPath technology features memory distributed to each processor with integrated memory controllers and high-speed point-to-point interconnects to unleash the performance of future versions of next-generation Intel® multi-core processors.
- Multi-level shared cache improves performance and efficiency by reducing latency to frequently used data.

Turbo Boost Technology

This technology now built into Xeon 5500 processors will increase the speed of your processor on demand (from OS) if the CPU is operating below power / thermal specifications:

- Benefit of Turbo Boost (how much CPU speed up) depends on number of active cores
- Likelihood of Turbo Boost operation increases when less cores are active
- Likelihood of Turbo Boost operation increases when dynamic power mgt is enabled

Technical Specifications - Hard Drives

HP SAS (Serial Attached
SCSI) Hard Drives for HP
Workstations

300 GB (15K)	Capacity	300 GB	
	Height	1 in; 2.5 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.2 cm
	Interface	SAS	
	Synchronous Transfer Rate (Maximum)	3.0 Gb/s	
	Buffer	16 MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.2 ms
		Average	3.5 ms
		Full Stroke	6.7 ms
	Rotational Speed	15,000 rpm	
	Logical Blocks	585,937,500 - 512 byte blocks	
	Operating Temperature	50° to 95° F (10° to 35° C)	
146 GB (15K)	Capacity	146 GB	
	Height	1 in; 2.5 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.2 cm
	Interface	SAS	
	Synchronous Transfer Rate (Maximum)	3.0 Gb/s	
	Buffer	16 MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.2 ms
		Average	3.5 ms
		Full Stroke	6.7 ms
	Rotational Speed	15,000 rpm	
	Logical Blocks	86,749,488 - 512 byte blocks	
	Operating Temperature	50° to 95° F (10° to 35° C)	
450 GB (15K)	Capacity	450 GB	
	Height	1 in; 2.5 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.2 cm
	Interface	SAS	
	Synchronous Transfer Rate (Maximum)	3.0 Gb/s	
	Buffer	16 MB	

Technical Specifications - Hard Drives

Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.2 ms
	Average	3.6 ms
	Full Stroke	6.6 ms
Rotational Speed	15,000 rpm	
Logical Blocks	879, 097, 968 - 512 byte blocks	
Operating Temperature	50° to 95° F (10° to 35° C)	

SATA (Serial ATA) Hard Drives for HP Workstations 160,041,885,696 bytes (10K)

Capacity	160,041,885,696 bytes	
Height	1 in; 2.5 cm	
Width	Media Diameter	3.5 in; 8.9 cm
	Physical Size	4 in; 10.2 cm
Interface	Serial ATA (1.5 Gb/s), Native Command Queuing enabled	
Synchronous Transfer Rate (Maximum)	Up to 150 MB/s	
Buffer	16 Mbytes	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.3 ms
	Average	4.6 ms
	Full Stroke	10.2 ms
Rotational Speed	10,000 rpm	
Logical Blocks	312,581,808	
Operating Temperature	41 to 131 F (5 to 55 C)	

1,000,204,886,016 bytes (7,200)

Capacity	1,000,204,886,016 bytes	
Height	1 in; 2.5 cm	
Width	Media Diameter	3.5 in; 8.9 cm
	Physical Size	4 in; 10.2 cm
Interface	Serial ATA (3.0 Gb/s), Native Command Queuing enabled	
Synchronous Transfer Rate (Maximum)	Up to 300 MB/s	
Buffer	32 MB	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track	2 ms
	Average	11 ms
	Full Stroke	21 ms
Rotational Speed	7,200 rpm	
Logical Blocks	1,953,525,168	
Operating Temperature	41 to 131 F (5 to 55 C)	

500,107,862,016

Capacity	500,107,862,016 bytes
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Technical Specifications - Hard Drives

bytes (7,200)	Height	1 in; 2.5 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.2 cm
	Interface	Serial ATA (3.0 Gb/s), Native Command Queuing enabled	
	Synchronous Transfer Rate (Maximum)	300 MB/s	
	Buffer	16 MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	2 ms
		Average	11 ms
		Full Stroke	21 ms
	Rotational Speed	7,200 rpm	
Logical Blocks		976,773,168	
Operating Temperature		41 to 131 F (5 to 55 C)	

250,059,350,016 bytes (7,200)	Capacity	250,059,350,016 bytes	
	Height	1 in; 2.5 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.2 cm
	Interface	Serial ATA (3.0 Gb/s), Native Command Queuing enabled	
	Synchronous Transfer Rate (Maximum)	300 MB/s	
	Buffer	16 MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	2 ms
		Average	11 ms
		Full Stroke	21 ms
Rotational Speed	7,200 rpm		
Logical Blocks	488,397,168		
Operating Temperature	41 to 131 F (5 to 55 C)		

160,041,885,696 bytes (7,200)	Capacity	160,041,885,696 bytes	
	Height	1 in; 2.5 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.2 cm
	Interface	Serial ATA (3.0 Gb/s), Native Command Queuing enabled	
	Synchronous Transfer Rate (Maximum)	300 MB/s	
	Buffer	8 MB	

Technical Specifications - Hard Drives

		Seek Time (typical reads, includes controller overhead, including settling)	Single Track	2 ms
			Average	11 ms
			Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	312,581,808	
		Operating Temperature	41 to 131 F (5 to 55 C)	
	300,069,052,416 bytes (10K)	Capacity	300,069,052,416 bytes	
		Height	0.6 in; 1.53 cm	
		Width	Media Diameter	2.5 in; 6.36 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (3.0Gb/s), Native Command Queuing enabled	
		Synchronous Transfer Rate (Maximum)	Up to 300 MB/s	
		Buffer	16 MB	
		Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.7 ms (maximum)
			Average	4.4 ms
			Full Stroke	9.5 ms
	320,072,933,376 bytes (7,200)	Rotational Speed	10,000 rpm	
		Logical Blocks	586,072,368	
		Operating Temperature	41° to 131° F (5° to 55° C)	
		Capacity	320,072,933,376 bytes	
		Height	0.98 in; 2.5 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4.0 in; 10.17 cm
		Interface	Serial ATA (3.0 Gb/s), Native Command Queuing enabled	
		Synchronous Transfer Rate (Maximum)	300 MB/s	
		Buffer	8 MB	
		Seek Time (typical reads, includes controller overhead, including settling)	Single Track	2
			Average	12
			Full Stroke	21
		Rotational Speed	7,200 rpm	
		Logical Blocks	625,142,448	
		Operating Temperature	41° to 131° F (5° to 55° C)	

Technical Specifications - Hard Drive Controllers

LSI 3041E 4-Port SAS 3.0 Gb/s RAID Card	PCI Bus	PCI-Express x4 lanes
	PCI Modes	Bus Master DMA
	RAID Levels	RAID 0, 1, 1E and 10E
	PCI Data Burst Transfer Rate	250 MB/s per lane half duplex 500 MB/s per lane full duplex 1,000 MB/s 4-lane half duplex
	SAS Bandwidth	Half Duplex
		Single lane – 300 MB/s Wide Port (2 lanes) – 600 MB/s Wide Port (4 lanes) – 1200 MB/s
	SAS Bandwidth	Full Duplex
		Single SAS Lane – 600 MB/s Wide Port (2 lanes) – 1200 MB/s Wide Port (4 lanes) – 2400 MB/s
	PCI Card Type	3.3 volt add-in c
	PCI Voltage	12 V $\pm$ 10%
	PCI Power	7.5 Watts
	Bracket	Full height and Low-profile
	Certification Level	PCI-Express 1.0a
	IO Bus	Four 3 Gb/s SAS/SATA ports
	SAS Processor	LSISAS1064E
	Internal Connectors	Four- SATA x1 connectors
	External Connectors	None
	Maximum Number of SCSI Devices	122
	LED Indicators	On-board activity and fault LEDs
	Integrated Mirroring	Integrated Mirroring option available

LSI MegaRAID® SAS 8888ELP Host Bus Adapter (HBA)	PCI Bus	PCI-Express x8 lanes
	PCI Modes	Bus Master DMA
	RAID Levels	RAID 0, 1, and 5 RAID spans 10 and 50
	PCI Data Burst Transfer Rate	Up to 3Gb/s per port
	Full Duplex	Up to 1.5 GB/s
	PCI Voltage	+3.3V Add-in Card
	PCI Power	7.5 Watts
	Certification Level	PCI-Express 1.0a
	IO Bus	Eight 3Gb/s SAS/SATA ports
	Internal Connectors	Two SAS SFF8087 x4
	External Connectors	Two SAS SFF8088 x4
	Maximum Number of SCSI Devices	32

Technical Specifications - Hard Drive Controllers

LED Indicators

Connector LEDs indicate whether the internal or external connector is active for ports 0-3 and 4-7

Technical Specifications - Graphics

NVIDIA Quadro NVS 295 Form Factor 256MB Graphics Card	Graphics Controller	2.731 inches (H) × 6.600 inches (L), Half-Height NVIDIA Quadro NVS 295 Graphics Board
	Bus Type	PCI Express x16, Generation 2.0
	Memory	256 MB GDDR3 SDRAM unified graphics memory
	Connectors	2 DisplayPort Comes with 2 DisplayPort to DVI-D Adapters (‘DisplayPort to VGA’ and ‘DisplayPort to DL DVI’ adapters available as an accessory)
	Maximum Resolution	Two DisplayPort outputs drive two digital displays up to 2560 x 1600
	Display Output	• Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking • Drives DVI enabled digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking (through DisplayPort to DVI-D (single link) cable)
	Supported Graphics APIs	OpenGL 3.0 DirectX 10.0
	Available Graphics Drivers	Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	Power consumption	22.69 Watts

NVIDIA Quadro NVS 450 Form Factor 512 MB PCIe Graphics Card	Bus Type	ATX Full Height, 1/2 length Passive cooling
	Memory	512 MB GDDR3 (256MB per GPU)
	Connectors	Four DisplayPort; Four DisplayPort to DVI-D adapters included. (‘DisplayPort to VGA’ and ‘DisplayPort to Dual Link DVI’ adapters available as an accessory)
	Maximum Resolution	DisplayPort connectors support ultra-high-resolution panels (up to 2560 x 1600)
	Supported Graphics APIs	OpenGL 3.0 Direct X 10.0
	Available Graphics Drivers	Genuine Microsoft Windows Vista(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation HP qualified drivers may be preloaded or available from the HP support web site: http://welcome.hp.com/country/us/eng/software_drivers.html . Novell SUSE Linux Enterprise drivers may be obtained from:

Technical Specifications - Graphics

<ftp://download.nvidia.com/novell> or <http://www.nvidia.com>

Power consumption 35 Watts

NVIDIA Quadro NVS 290 256 MB PCIe Graphics Card	Form Factor	Low Profile
	Bus Type	PCIe x16
	Memory	256 MB 400MHz DDR2 SDRAM unified frame buffer, Z-buffer and Texture storage
	Connectors	DMS-59, includes DMS-59 to Dual DVI-I cable. DMS-59 to Dual VGA cable available as an option.
	Maximum Resolution	Dual integrated analog display controllers supporting up to two analog displays at 2048x1536 @ 85Hz on both displays or dual digital displays at 1920x1200 (single-link). NVIEW advanced multi-display desktop and application management seamlessly integrated into Microsoft® Windows®
	RAMDAC	Integrated dual 400MHz
	Image Quality Features	Full-screen, full-frame video playback of HDTV and DVD content DVD-ready motion compensation for MPEG-2 Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0) IDCT motion compensation 5-tap horizontal by 3-tap vertical filtering 8:1 up/down scaling
	Programmable Video Processor	Full-screen, full-frame video playback of HDTV and DVD content DVD-ready motion compensation for MPEG-2 Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0) IDCT motion compensation 5-tap horizontal by 3-tap vertical filtering 8:1 up/down scaling
	Display Output	Dual integrated analog display controllers supporting up to two analog displays at 2048x1536 @ 85Hz on both displays or dual digital displays at 1920x1200 (single-link). NVIEW advanced multi-display desktop and application management seamlessly integrated into Microsoft® Windows®
	Supported Graphics APIs	OpenGL 2.1 & DirectX 10 Support; Shader Model 4.0
	Available Graphics Drivers	Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit)(Provides full native Dual View mode, Span or Big Desktop mode, and Clone mode) Red Hat Enterprise Linux(RHEL) WS3, WS4 & 5 Desktop/Workstation HP qualified drivers may be preloaded or available from the HP support web site: http://welcome.hp.com/country/us/eng/software_drivers.html . Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	High-Resolution AntiAliasing	Color planes: 32-bit color buffer Overlay planes: Hardware supported

Technical Specifications - Graphics

CUDA™ Parallel Processor Cores

NVIDIA Quadro NVS 290 (256 MB DH) PCIe Graphics Card with full height bracket attached, DMS-59 to Dual DVI cable, Workstation Software Driver CD, documentation.

NVIDIA Quadro FX 380 256MB Graphics Card

Form Factor

4.376 inches (H) × 6.60 inches (L)

Graphics Controller

NVIDIA Quadro FX 380 Graphics Board

Bus Type

PCI Express x16, Generation 2.0

Memory

256 MB GDDR3 SDRAM unified graphics memory

Connectors

2 Dual Link DVI-I

Two DVI-I to VGA adapters included

Maximum Resolution

Two dual-link DVI-I outputs drive two digital displays at resolutions up to 2560 x 1600 @ 60Hz or two analog displays at resolutions up to 2048 x 1536 @ 85Hz

RAMDAC

Dual Internal 400 MHz DAC

Shading architecture

Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

- Long fragment programs (unlimited instructions)
- Long vertex programs (unlimited instructions)
- Looping and subroutines (up to 256 loops per vertex program)
- Dynamic flow control
- Conditional execution

Supported graphics APIs

OpenGL 3.0

Direct X 10.0

Available graphics drivers

Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support Web site: <http://welcome.hp.com/country/us/en/support.html>

Novell SUSE Linux Enterprise drivers may be obtained from:

<ftp://download.nvidia.com/novell> or <http://www.nvidia.com>

High-level Shader Languages

- Optimized compiler for Cg and Microsoft HLSL
- OpenGL 2.1 and DirectX 10 support
- Open source compiler

CUDA™ Parallel Processor Cores

16

Power consumption

33.91 Watts

Technical Specifications - Graphics

ATI FirePro V3700 256MB Graphics Card	Form Factor	4.40 inches (H) × 6.70 inches (L) (11.18 cm (H) × 17.02 cm (L))
	Graphics Controller	ATI FirePro V3700 Graphics Board
	Bus Type	PCI Express x16, Generation 2.0
	Memory	256 MB GDDR3 SDRAM unified graphics memory
	Connectors	2 Dual Link DVI-I Two DVI-I to VGA adapters included
	Maximum Resolution	Two dual-link DVI-I outputs drive two digital displays at resolutions up to 2560 x 1600 @ 60Hz or two analog displays at resolutions up to 2048 x 1536 @ 85Hz
	Shading architecture	Full Shader Model 4.0 ● 40 Stream Processing Units ● Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders ● Common instruction set and texture unit access supported for all types of shaders ● Dedicated branch execution units and texture address processors
	Supported graphics APIs	OpenGL 2.1 DirectX 10.1
	Available graphics drivers	Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Linux drivers may be obtained from: http://ati.amd.com/support/driver.html
	Power consumption	32 Watts

NVIDIA Quadro FX 580 512MB Graphics Card	Form Factor	4.376 inches (H) × 6.60 inches (L)
	Graphics Controller	NVIDIA Quadro FX 580 Graphics Board
	Bus Type	PCI Express x16, Generation 2.0
	Memory	512MB GDDR3 SDRAM unified graphics memory
	Connectors	2 DisplayPort, 1 Dual-Link DVI-I. One DisplayPort to DVI and one DVI to VGA adapter included (‘DisplayPort to VGA’ and ‘DisplayPort to Dual Link DVI’ adapters available as an accessory)
	Maximum Resolution	● Two DisplayPort outputs drive two digital displays up to 2560 x 1600 ● One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1536 @ 85Hz
	RAMDAC	Single Internal 400 MHz DAC
	Shading architecture	Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class) ● Long fragment programs (unlimited instructions)

Technical Specifications - Graphics

	• Long vertex programs (unlimited instructions) • Looping and subroutines (up to 256 loops per vertex program) • Dynamic flow control • Conditional execution
Supported graphics APIs	OpenGL 3.0 Direct X 10.0
Available graphics drivers	Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
High-level Shader Languages	• Optimized compiler for Cg and Microsoft HLSL • OpenGL 2.1 and DirectX 10 support • Open source compiler
CUDA™ Parallel Processor Cores	32
Power consumption	40 Watts

NVIDIA Quadro FX 1800 768MB Graphics Card	Form Factor 4.376 inches (H) x 7.8 inches (L) Graphics Controller NVIDIA Quadro FX 1800 Graphics Board Bus Type PCI Express x16, Generation 2.0 Memory 768MB GDDR3 SDRAM unified graphics memory Connectors 2 DisplayPort, 1 Dual-Link DVI-I. One DisplayPort to DVI-D and one DVI to VGA adapter included ('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)
Maximum Resolution	• Two DisplayPort outputs drive two digital displays up to 2560 x 1600 • One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1536 @ 85Hz
RAMDAC	Single Internal 400 MHz DAC
Shading Architecture	Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class) • Long fragment programs (unlimited instructions) • Long vertex programs (unlimited instructions) • Looping and subroutines (up to 256 loops per vertex program) • Dynamic flow control • Conditional execution
Supported Graphics APIs	OpenGL 3.0 Direct X 10.0
Available Graphics Drivers	Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit)

Technical Specifications - Graphics

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Novell SUSE Linux Enterprise drivers may be obtained from:

<ftp://download.nvidia.com/novell> or <http://www.nvidia.com>

High-level Shader Languages

- Optimized compiler for Cg and Microsoft HLSL
- OpenGL 2.1 and DirectX 10 support
- Open source compiler

CUDA™ Parallel Processor Cores

64.

Power consumption

59 Watts

ATI FirePro V5700 512MB Graphics Card

Form Factor

4.40 inches (H) × 6.70 inches (L) (11.18 cm (H) × 17.02 cm (L))

Graphics Controller

ATI FirePro V5700 Graphics Board

Bus Type

PCI Express x16, Generation 2.0

Memory

512 MB GDDR3 SDRAM unified graphics memory

Connectors

2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI and one DVI to VGA adapter included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)

Maximum Resolution

- Two DisplayPort outputs drive two digital displays up to 2560 x 1600
- One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1536 @ 85Hz

Shading architecture

Full Shader Model 4.0

- 320 Stream Processing Units
- Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders
- Common instruction set and texture unit access supported for all types of shaders
- Dedicated branch execution units and texture address processors

Supported graphics APIs

OpenGL 2.1
DirectX 10.1

Available graphics drivers

Genuine Windows Vista Business (64-bit and 32-bit)
Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Linux drivers may be obtained from:

<http://ati.amd.com/support/driver.html>

Power consumption

56 Watts

Technical Specifications - Graphics

NVIDIA Quadro FX 3800 1.0GB Graphics Card (NOT AVAILABLE UNTIL JUNE 2009)	Form Factor	4.376 inches (H) x 9.0 inches (L) Single slot card
	Graphics Controller	NVIDIA Quadro FX 3800 Graphics Board
	Bus Type	PCI Express x16, Generation 2.0
	Memory	1GB GDDR3 SDRAM unified graphics memory
	Connectors	2 DisplayPort, 1 Dual-Link DVI-I. One DisplayPort to DVI-D and one DVI to VGA adapter included
		('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)
	Maximum Resolution	• Two DisplayPort outputs drive two digital displays up to 2560 x 1600 • One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1536 @ 85Hz
	RAMDAC	Single Internal 400 MHz DAC
	Shading architecture	Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class) • Long fragment programs (unlimited instructions) • Long vertex programs (unlimited instructions) • Looping and subroutines (up to 256 loops per vertex program) • Dynamic flow control • Conditional execution
	Supported graphics APIs	OpenGL 3.0 Direct X 10.0
	Available graphics drivers	Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	High-level Shader Languages	• Optimized compiler for Cg and Microsoft HLSL • OpenGL 2.1 and DirectX 10 support • Open source compiler
	CUDA™ Parallel Processor Cores	192
	Power consumption	107.9 Watts

Technical Specifications - Graphics

ATI FirePro V7750 1.0GB Form Factor Graphics Card	4.40 inches (H) × 13.0 inches (L) (11.18 cm (H) × 33.02 cm (L))
Graphics Controller	ATI FirePro V7750 Graphics Board
Bus Type	PCI Express x16, Generation 2.0
Memory	1024 MB GDDR3 SDRAM unified graphics memory
Connectors	2 DisplayPort, 1 Dual-Link DVI-I. One DisplayPort to DVI and one DVI to VGA adapter included (‘DisplayPort to VGA’ and ‘DisplayPort to Dual Link DVI’ adapters available as an accessory)
Maximum Resolution	• Two DisplayPort outputs drive two digital displays up to 2560 x 1600 • One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1536 @ 85Hz
Shading architecture	Full Shader Model 4.0 • 320 Stream Processing Units • Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders • Common instruction set and texture unit access supported for all types of shaders • Dedicated branch execution units and texture address processors
Supported graphics APIs	OpenGL 2.1 DirectX 10.1
Available graphics drivers	Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Linux drivers may be obtained from: http://ati.amd.com/support/driver.html
Power consumption	76 Watts

Technical Specifications - Graphics

NVIDIA Quadro FX 4800 Form Factor 1.5GB PCIe Graphics Card		4.36" (H) x 10.5" (L) Dual slot card
Graphics Controller		NVIDIA Quadro FX 4800 graphics board
Bus Type		PCI Express x16, Generation 2.0
Memory		1.5 GB GDDR3 SDRAM unified graphics memory
Connectors		2 DisplayPort, 1 Dual-Link DVI-I, 1 3-pin Mini DIN stereo output, Two DisplayPort to DVI-D adapters included (DisplayPort to VGA and DisplayPort to Dual Link DVI adapters available as an accessory)
Maximum Resolution		2 DisplayPort connectors support ultra-high-resolution panels (up to 2560 x 1600) - Dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz - Internal 400 MHz DACs-One analog display up to 2048 x 1536 @ 85Hz
Shading Architecture		- Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class) - Long fragment programs (unlimited instructions) - Long vertex programs (unlimited instructions) - Looping and subroutines (up to 256 loops per vertex program) - Dynamic flow control - Conditional execution
Supported Graphics APIs		OpenGL 3.0 Direct X 10.0
Available Graphics Drivers		Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
High-Resolution AntiAliasing		- Rotated Grid Full-Scene Antialiasing (RG FSAA) 32xFSAA dramatically reduces visual aliasing artifacts or "jaggies" at resolution up to 1920 x 1200 64x FSAA SLI Mode
High-level Shader Languages		- Optimized compiler for Cg and Microsoft HLSL - OpenGL 2.1 and DirectX 10 support - Open source compiler
CUDA™ Parallel Processor Cores		192
Power consumption		146 Watts

Technical Specifications - Graphics

NVIDIA Quadro CX	Form Factor	4.36" (H) x 10.5" (L) Dual slot card
	Graphics Controller	NVIDIA Quadro CX 1.5GB Graphics Card
	Bus Type	PCI Express x16, Generation 2.0
	Memory	1.5 GB GDDR3 SDRAM unified graphics memory
	Connectors	2 DisplayPort, 1 Dual-Link DVI-I, 1 3-pin Mini DIN stereo output. Two DisplayPort to DVI-D adapters included
		('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)
	Maximum Resolution	• 2 DisplayPort connectors support ultra-high-resolution panels (up to 2560 x 1600) • Dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz • Internal 400 MHz DACs-One analog display up to 2048 x 1536 @ 85Hz
	RAMDAC	400MHz
	Shading Architecture	• Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class) • Long fragment programs (unlimited instructions) • Long vertex programs (unlimited instructions) • Looping and subroutines (up to 256 loops per vertex program) • Dynamic flow control • Conditional execution
	Supported Graphics APIs	OpenGL 3.0 Direct X 10.0
	Available Graphics Drivers	Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	High-Resolution AntiAliasing	• Rotated Grid Full-Scene Antialiasing (RG FSAA) • 32xFSAA dramatically reduces visual aliasing artifacts or "jaggies" at resolution up to 1920 x 1200 • 64x FSAA SLI Mode
	High-level Shader Languages	• Optimized compiler for Cg and Microsoft HLSL • OpenGL 2.1 and DirectX 10 support • Open source compiler
	CUDA™ Parallel Processor Cores	192
	Power consumption	146 Watts

Technical Specifications - Multimedia and Audio Devices

Integrated Intel/Realtek HD ALC262 Audio	Type	Integrated
	High Definition Codec	Yes
	FM Synthesis Support	Yes
	OPL3 FM Synthesis Support	Yes
	Sound Blaster Compatibility	Yes
	Meets Premium performance for Windows Logo Program 3.0	Yes
	Audio Jacks	Front panel microphone in and headphone out - fixed usage. Rear panel line in and line out jacks - jacks are retaskable One Line-In* (12-K ohm Input Impedance)* NOTE: External Speakers need to be powered externally.
	Sampling	3 stereo ADCs support 16/20-bit PCM format with 44.1K/48K/96kHz sample rate 2 stereo DAC supports 16/20/24-bit PCM format with 44.1K/48K/96K/192kHz sample rate
	Wavetable Syntheses (software)	Yes – GM and FM Midi Support, Direct Music and Down Loadable Soundset (4 Meg DLS Level 1 and 2 Support)
	3D Positional Sound	No
	Digital Audio	Yes
	Analog Audio	Yes
	DVD Audio	Yes
	Number of Channels on Line-Out	Stereo (Left & Right channels)
	Internal Audio Speaker Power Rating	1.5 W
	Internal Speaker	Yes
	Hardware Equalizer for Internal Speaker	No
	External Speaker Jack (Line-Out)	Yes

Technical Specifications - Multimedia and Audio Devices

SoundBlaster (Creative Labs) X-Fi Titanium PCIe Audio Card	24-bit Analog-to-Digital conversion of analog inputs	96kHz sample rate
	24-bit Digital-to-Analog conversion of digital sources	96kHz to analog 7:1 speaker output
	24-bit Digital-to-Analog conversion of stereo digital sources	8, 11.025, 16, 22.05, 24, 32, 44.1, 48 and 96kHz
	16-bit to 24-bit recording sampling rates	16-bit/44.1kHz, 16-bit/48kHz, 24-bit/44.1kHz, 24-bit/48kHz and 24-bit/96kHz with direct monitoring
	Enhanced SoundFont support	Up to 24-bit resolution
	Signal-to-Noise Ratio (20kHz Low-pass filter, A-Weighted)	109dB
	Total Harmonic Distortion + Noise at 1kHz (20kHz Low-pass filter)	.004%
	Frequency Response (-3dB, 24-bit/96kHz input)	10Hz to 46kHz
	Frequency Response (-3dB, 24-bit/192kHz input)	10Hz to 46kHz
	Speaker and Headphone connections	Stereo to 7.1 (Line Out via three 3.5mm mini jacks)
	Flexijack	Line In/ Microphone In/Optical Out via shared 3.5mm mini jack
	Front Panel Header	Intel HD Audio Compatible (2x5 pin)
	Operating System	Microsoft Windows Vista Business 64 Microsoft Windows Vista Business 32 Microsoft® Windows® XP Professional SP2 Microsoft Windows XP Professional x64 Edition
Minimum System Requirements	System RAM	512MB
	Operating System	Windows Vista 32-bit and 64-bit version or Windows XP 32-bit or 64-bit version

Technical Specifications - Optical and Removable Storage

NOTE 1: Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

HP DVD-ROM Drive	Description	5.25-inch, half-height, tray-load
	Mounting Orientation	Either horizontal or vertical
	Interface Type	SATA/ATAPI
	Dimensions (WxHxD)	5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)
	Disc Capacity	DVD-ROM Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB
	Access Times	DVD-ROM Single Layer < 140 ms (typical) CD-ROM Mode 1 < 125 ms (typical) Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)
	Power	Source SATA DC power receptacle DC Power Requirements 5 VDC $\pm$ 5%-100 mV ripple p-p 12 VDC $\pm$ 5%-200 mV ripple p-p DC Current 5 VDC - < 1000 mA typical, < 1600 mA maximum 12 VDC - < 600 mA typical, < 1400 mA maximum
	Operating Environmental (all conditions non-condensing)	Temperature 41° to 122° F (5° to 50° C) Relative Humidity 10% to 90% Maximum Wet Bulb Temperature 86° F (30° C)
	Operating Systems Supported	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS3, WS4, 5 Desktop/Workstation Novell SLES 9 & SLE 10 No driver is required for this device. Native support is provided by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: <http://www.windowsvista.com/upgradeadvisor>. For Windows Vista system requirements, visit: <http://www.windowsvista.com/systemrequirements>.

Technical Specifications - Optical and Removable Storage

HP DVD+/-RW Drive	Description	5.25-inch, half-height, tray-load	
	Mounting Orientation	Either horizontal or vertical	
	Interface Type	SATA/ATAPI	
	Dimensions (WxHxD)	5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)	
	Disc Formats	DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW	
	Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard
		Full Stroke DVD	< 250 ms (seek)
		Full Stroke CD	< 210 ms (seek)
	Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 40X CD-RW Up to 32X
		DVD ROM Read	DVD-RAM Up to 12X DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 16X DVD-ROM DL Up to 8X DVD+R Up to 16X DVD-R Up to 16X
	Power	Source	SATA DC power receptacle
		DC Power Requirements	5 VDC $\pm$ 5%-100 mV ripple p-p 12 VDC $\pm$ 5%-200 mV ripple p-p
		DC Current	5 VDC -1000 mA typical, 1600 mA maximum 12 VDC -600 mA typical, 1400 mA maximum
	Operating Environmental (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)
		Relative Humidity	10% to 90%
		Maximum Wet Bulb Temperature	86° F (30° C)
		Operating Systems Supported	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS3, WS4, 5 Desktop/Workstation Novell SLES 9 & SLE 10 No driver is required for this device. Native

Technical Specifications - Optical and Removable Storage

support is provided by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: <http://www.windowsvista.com/upgradeadvisor>. For Windows Vista system requirements, visit: <http://www.windowsvista.com/systemrequirements>.

* LightScribe functionality is not natively supported by Linux distributions. Customers may download LightScribe Linux drivers from: <http://www.lightscribe.com/downloadSection/linux/index.aspx>

Kit Contents

HP SATA SuperMulti LightScribe DVD Writer drive, LightScribe software, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation guide, and DVD+R media.

HP Slot Load DVD+/-RW Drive	Description	Slim-Line, Slot-load	
	Mounting Orientation	Either horizontal or vertical	
	Interface Type	SATA	
	Dimensions (WxHxD)	5 x .5 x 5 in (12.7 x 1.2 x 12.9 cm) 0	
	Disc Formats	DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW	
	Disc Capacity	DVD-ROM	5/9/10/18 G DVD-Single / Dual (PTP, OTP) (Read Only) 4.7G DVD±R/RW (Read & Write) DVD±R Dual (Read & Write) 80mm DVD DVD-RAM (Read & Write)
		CD-ROM	650 MB CD-ROM (Read Only) 80mm CD 800/700/650/ CD-Recordable (Read & Write) 700/650MB CD-Rewritable (Read & Write) 700/650MB High Speed CD-Rewritable (Read & Write) 700/650MB Ultra & Ultra+ Speed CD-Rewritable (Read & Write)
		Full Stroke DVD	< 270 ms (seek)
		Full Stroke CD	< 250 ms (seek)
	Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R and CD-RW Up to 24X
		DVD ROM Read	DVD-RAM Up to 5X DVD Single layer Up to 8X DVD Dual Layer up to 6X

Technical Specifications - Optical and Removable Storage

Power	Source	SATA DC power receptacle
	DC Power Requirements	5 VDC $\pm$ 5%-100 mV ripple p-p
Operating Environmental (all conditions non-condensing)	DC Current	5 VDC 40 mA typical, 800 mA maximum
	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 90%
	Operating Systems Supported	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS3, WS4, 5 Desktop/Workstation Novell SLES 9 & SLE 10 No driver is required for this device. Native support is provided by the operating system.
	Kit Contents	Factory integrated only. Not available as a kit.

HP Blu-Ray Writer

Description	5.25-inch, half-height, tray-load	
Mounting Orientation	Either horizontal or vertical	
Interface Type	SATA	
Dimensions (WxHxD)	5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)	
Disc Formats	BD-ROM	
	BD-R	
	BD-RE	
	DVD-RAM	
	DVD+R	
	DVD+RW	
	DVD+R DL	
	DVD-R DL	
	DVD-R	
	DVD-RW	
	CD-R	
	CD-RW	
	DVD-ROM	8.5 GB DL or 4.7 GB standard
	Blu-ray	50 GB DL or 25 GB standard
Disc Capacity	Full Stroke DVD	< 250 ms (seek)
	Full Stroke CD	< 210 ms (seek)
	Blu-ray	Blu-ray
	Startup Time (Time to drive ready from tray loading)	BD-ROM (SL/DL) 25S / 28S
		BD-R (SL/DL) 25S / 28S
		BD-RE (SL/DL) 25S / 28S
		DVD-ROM (SL/DL) 18S / 18S
		DVD-R (SL/DL) 25S / 25S
		DVD-RW 25S
		DVD+R (SL/DL) 25S / 25S
		DVD+RW 25S

Technical Specifications - Optical and Removable Storage

Maximum Data Transfer Rates	CD ROM Read	DVD-RAM	45S
		CD-ROM	45S
		CD-ROM	Up to 40X
		CD-R	Up to 40X
		CD-RW	Up to 40X
		DVD-ROM	Up to 5X
	DVD ROM Read	DVD+RW	Up to 10X
		DVD-RW	Up to 10X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-ROM	Up to 16X
		DVD-ROM DL	Up to 8X
	Blu-Ray	DVD+R	Up to 12X
		DVD-R	Up to 12X
		BD-ROM	Up to 6X
		BD-ROM DL	Up to 4.8X
		BD-R	Up to 6X
		BD-R DL	Up to 4.8X
Power	Source	BD-R	Up to 6X
		BD-RE SL/DL	Up to 4.8X
	DC Power Requirements	SATA DC power receptacle	
		5 VDC $\pm$ 5%-100 mV ripple p-p	
Operating Environmental (all conditions non-condensing)	DC Current	12 VDC $\pm$ 10%-100 mV ripple p-p	
		5 VDC -900 mA typical, 1200 mA maximum	
	Temperature	12 VDC -1000 mA typical, 1600 mA maximum	
		41° to 122° F (5° to 50° C)	
	Relative Humidity	15% to 80%	
		86° F (30° C)	
Operating Systems Supported	Maximum Wet Bulb Temperature	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*.	
		Red Hat Enterprise Linux(RHEL) WS3, WS4, 5 Desktop/Workstation	
Kit Contents	Operating Systems Supported	Novell SLES 9 & SLE 10	
		No driver is required for this device. Native support is provided by the operating system.	
Kit Contents	Kit Contents	HP Blue Laser RW Drive, LightScribe software, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation guide.	

Technical Specifications - Optical and Removable Storage

Disclaimer

As Blu-Ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

HP 22-in-1 Media Card Reader

Description

The Media Card Reader device uses the same physical form factor and mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash memory card formats that are supported.

Mounting Orientation

The Media Card Reader can be mounted in a dedicated Floppy Drive bay (if the chassis provides one) or in an appropriate Optical Bay adapter. It will operate in any orientation.

Interface Type

USB 2.0 (one channel dedicated to the separate USB port; one channel dedicated to the flash memory card slots)

Dimensions (WxHxD)

4.9 x 4.0 x 1.0 in (124.5 x 101.6 x 25.4 mm)

Disc Formats

xD-Picture
Micro SD
Micro SDHC
SD
SDHC
Mini SD
Mini SDHC
MultiMediaCard (MMC)
Reduced Size MultiMediaCard (RS MMC)
MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC)
Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mobile HC)
CompactFlash Card Type I
CompactFlash Card Type II
MicroDrive
Memory Stick (MS)
MagicGate Memory Stick (MG)
MagicGate Memory Stick Duo
Memory Stick Select
Memory Stick Duo (MS Duo)
Memory Stick PRO (MS PRO)
Memory Stick PRO Duo (MS PRO Duo)
Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied):
MMC Micro
Memory Stick Micro (M2)

Technical Specifications - Optical and Removable Storage

HP DX115 Removable Drive Enclosure	Interface Type	Compatible with SAS or SATA controllers
	Dimensions (WxHxL)	5.81 x 1.62 x 8.08 in (147.6 x 41.1 x 205 mm)
	Weight	Frame and Carrier: 3.8 lbs (1.73 kg) Carrier: 1 lbs (0.45 kg)

Technical Specifications - Controller Cards

HP FireWire/IEEE 1394a PCI Card	Data Transfer Rate	Burst Data Rate up to 400 Mbps
	Device Interface Protocol	IEEE-1394a
	Devices Supported	IEEE-1394 compliant devices
	Bus Type	PCI card with brackets for low profile and full height PCI slots.
	Certification Level	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Ports	Two IEEE 1394 6-Pin Connector (Rear)
	Internal Connectors	One 10-Pin (9 Contacts) Custom Connector
	System Requirements	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. No driver is required for this device. Native support is provided by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: <http://www.windowsvista.com/upgradeadvisor>. For Windows Vista system requirements, visit: <http://www.windowsvista.com/systemrequirements>.

Pentium II 266 or above
128-MB RAM
1-GB Hard Drive
CD-ROM drive
Built-in sound system
Available PCI slot

Temperature - Operating	50° to 131° F (10° to 55° C)
Temperature - Storage	-22° to 140° F (-30° to 60° C)
Relative Humidity - Operating	20% to 80%
Operating Systems Supported	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: <http://www.windowsvista.com/upgradeadvisor>. For Windows Vista system requirements, visit: <http://www.windowsvista.com/systemrequirements>.

Technical Specifications - Controller Cards

HP IEEE 1394b FireWire PCIe Card	Data Transfer Rate	Supports up to 800 Mbps
	Devices Supported	IEEE-1394 compliant devices
	Bus Type	PCIe card full height PCIe slots
	Ports	Two IEEE-1394b bilingual 9-Pin Connector (Rear)
	Internal Connectors	One 10-Pin header Custom Connector
	System Requirements	Microsoft Windows XP Professional, Windows XP Home, Windows Vista. Not supported on Linux. Pentium® III or higher processor 128-MB RAM 1-GB Hard Drive CD-ROM drive Built in sound system Available PCI slot
	Temperature – Operating	50° to 131° F (10° to 55° C)
	Temperature – Storage	–22° to 140° F (–30° to 60° C)
	Relative Humidity – Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	Microsoft Windows XP and Windows Vista

Technical Specifications - Networking and Communications

NOTE 1: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Integrated Broadcom 5764 PCIe LOM Controller	Connector	RJ45
	Data Rates Supported	10/100/1000BT
	Bus Architecture	PCIe X1
	Alerting	ASF 2.0
Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC	Connector	RJ-45
	Controller	Broadcom 5761 PCI-Express LAN Controller
	Memory	8 MB NVRAM serial Flash
	Data Rates Supported	10/100/1000 Mbps
	Compliance	IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x
	Bus Architecture	PCI-Express
	Data Path Width	Single Channel PCI-Express
	Data Transfer Mode	Bus Master DMA
	Hardware Certifications	FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed (E212044), European Union Notice (CE 0682)
	Power Requirement	1.8W @ 3.3V
	Boot ROM Support	Yes
	Network Transfer Mode	Full-duplex Half-duplex (not available for the 1000BASE-T transceiver)
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Operating Temperature	32° to 131°F (0° to 55° C)
	Operating Humidity	131° F (55° C) with 5% to 95% non-condensing humidity
	Dimensions	2.75 in x 4.13 in (7 cm x 10.5 cm), low profile compatible
	Operating System Driver Support	Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XP x64 .
	Management Capabilities	ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility, ASF2.0, DASH 1.0 and DASH 1.1 profiles
	Kit Contents	Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick install guide, product warranty statement

Technical Specifications - Networking and Communications

HP NC360T PCI Express Dual Port Gigabit NIC	Connector	Two RJ-45
	Controller	Intel 82571EB
	Memory	Integrated 96KB
	Data Rates Supported	10/100/1000 Mbps
	Compliance	802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q
	Bus Architecture	PCI-E 1.0a
	Data Path Width	Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI Express slots
	Data Transfer Mode	Bus-master DMA
	Hardware Certifications	FCC Class B, VCCI Class B, BSMI Class A, CISPR 22 Class B, EN 55022 Class B, EN55024-1, ICES-003 Class B, MIC Class B, ACA Class B, UL, Canada UL, EN60950
	Power Requirement	1280 mA @ 3.3V typical
	Boot ROM Support	Yes
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Operating Temperature	32° to 131°F (0° to 55° C)
	Operating Humidity	0% to 95% non-condensing
	Dimensions	5.1 x 2.7 in (12.95 x 6.8 cm)
	Operating System Driver Support	Windows Vista Business 64*, Windows Vista Business 32*, Windows XP Professional, Windows XP Professional x64 Edition. Red Hat Enterprise Linux(RHEL) WS4, 5 Desktop/Workstation Novell SLES 9 & SLE 10
		* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements.
	Management Capabilities	WOL , PXE 2.1
	Kit Contents	HP NC360T PCI Express Dual Port Gigabit NIC, low profile bracket, CD containing Intel PROset II NIC drivers, quick install guide, product warranty statement

Technical Specifications - Networking and Communications

Intel Gigabit CT Desktop NIC	Connector	RJ-45
	Controller	Intel WG82574L Gigabit Ethernet Controller
	Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers
	Data Rates Supported	10/100/1000 Mbps
	Compliance	IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x flow control
	Bus Architecture	PCI-E 1.0a
	Data Path Width	X1, 250 MB/s, Bi-directional interface
	Data Transfer Mode	Bus-master DMA
	Hardware Certifications	FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union
	Power Requirement	Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T
	Boot ROM Support	Yes
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Operating Temperature	32° to 131°F (0° to 55° C)
	Operating Humidity	85% at 131° F (55° C)
	Dimensions	4.75 x 2.25 x 0.8 in (12.1 x 5.7 x 2.0 cm)
	Operating System Driver Support	Windows Vista Business 64, Windows Vista Business 32, Windows XP Professional, Windows XP x64. Red Hat Enterprise Linux 4, Red Hat Enterprise Linux 5.
	Management Capabilities	WOL, PXE, DMI, WFM 2.0
	Kit Contents	Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel PROset II NIC drivers, quick install guide, product warranty statement

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